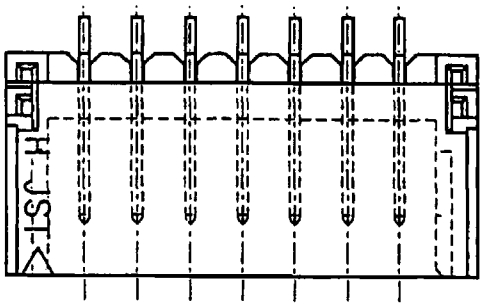
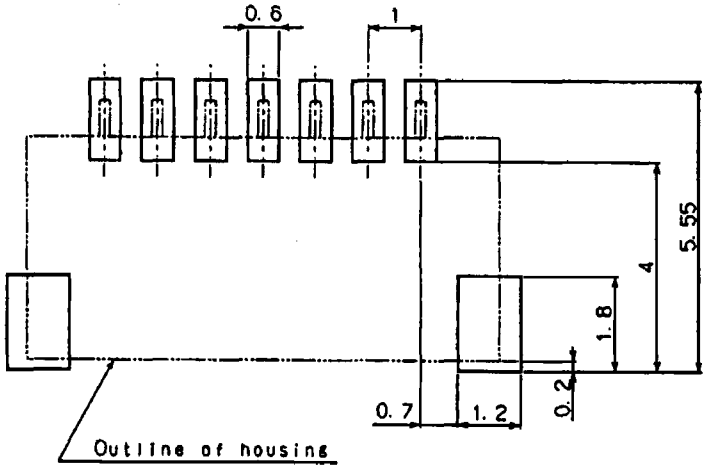
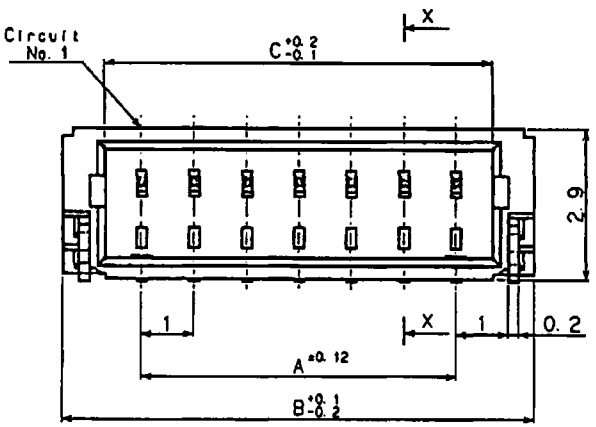
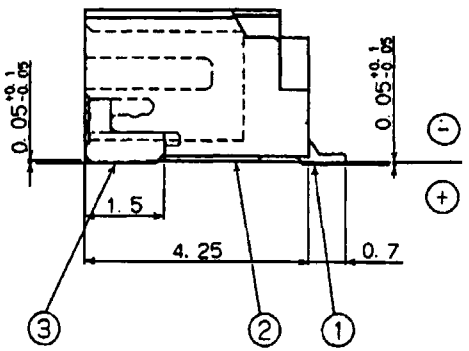
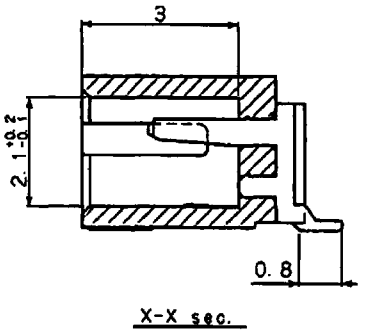




P. C. Board layout







Circuits	Dimensions		
	A	B	C
2	1.0	4.0	2.4
3	2.0	5.0	3.4
4	3.0	6.0	4.4
5	4.0	7.0	5.4
6	5.0	8.0	6.4
7	6.0	9.0	7.4
8	7.0	10.0	8.4
9	8.0	11.0	9.4
10	9.0	12.0	10.4
11	10.0	13.0	11.4
12	11.0	14.0	12.4
13	12.0	15.0	13.4
14	13.0	16.0	14.4
15	14.0	17.0	15.4

NOTE

1. Unless otherwise specified, tolerances are
   0<L≤1.0: ±0.15. 1.0<L≤3.0: ±0.2. 3.0<L : ±0.3
2. Dispersion of soldertail length should be 0.1mm MAX.

No.	NAME	MATERIAL	REMARKS
3	SOLDER TAB	BRASS, t0.2	COPPER-UNDERPLATED TIN/LEAD ALLOY-PLATED
2	WAFER	POLYAMIDE	UL94V-0, NATURAL
1	BASE CONTACT	COPPER ALLOY t0.2	COPPER-UNDERPLATED TIN/LEAD ALLOY-PLATED

REVISIONS

J. S. T.

APPROVED BY	CHECKED BY	DRAWN BY	SCALE	PROJECTION	DATE
T.N	S.S.	M.Y	free		JUL. 15 1997

PART NAME	SR CONNECTOR
PART No.	SM( )B-SRSS
DRAWING No.	KRD-20271

EC4109-1

JSTSM0209